



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	TLD5190QV	<b>Issued</b>	18. May 2021
<b>MA#</b>	MA005543405		
<b>Package</b>	PG-VQFN-48-31	<b>Weight*</b>	129.30 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.790	1.38	1.38	13846	13846
leadframe	inorganic material	phosphorus	7723-14-0	0.018	0.01		139	
	non noble metal	zinc	7440-66-6	0.072	0.06		554	
	non noble metal	iron	7439-89-6	1.433	1.11		11084	
	non noble metal	copper	7440-50-8	58.193	45.01	46.19	450074	461851
wire	non noble metal	copper	7440-50-8	0.635	0.49	0.49	4915	4915
encapsulation	organic material	carbon black	1333-86-4	0.190	0.15		1469	
	plastics	epoxy resin	-	8.040	6.22		62186	
	inorganic material	silicondioxide	60676-86-0	55.080	42.60	48.97	425998	489653
leadfinish	non noble metal	tin	7440-31-5	2.596	2.01	2.01	20081	20081
plating	noble metal	silver	7440-22-4	0.614	0.47	0.47	4747	4747
glue	plastics	epoxy resin	-	0.146	0.11		1129	
	noble metal	silver	7440-22-4	0.489	0.38	0.49	3778	4907
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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